



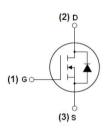
MJ N-Channel Enhancement Mode Power MOSFET

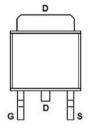
Description

The MJ8050AK uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

- ♦ $V_{DS} = 80V, I_D = 50A$ $R_{DS(ON)} < 16m\Omega$ @ $V_{GS} = 10V$ (Typ:13mΩ)
- ♦ High density cell design for ultra low Rdson
- ◆ Fully characterized avalanche voltage and current
- ◆ Good stability and uniformity with high EAS
- ◆ Excellent package for good heat dissipation
- ◆ Special process technology for high ESD capability



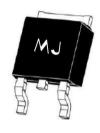


Application

◆ Power switching application

Uninterruptible power supply

Hard switched and High frequency circuits



Schematic diagram

Marking and pin assignment

TO-252-2L top view

100% UIS TESTED! 100% ΔVds TESTED!

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
MJ8050AK	MJ8050AK	TO-252-2L	-	-	-

Absolute Maximum Ratings (Tc =25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	80	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	lo	50	А
Drain Current-Continuous(Tc =100°C)	ID(100°C)	35.4	А
Pulsed Drain Current	IDM	85	А
Maximum Power Dissipation	Po	110	W
Derating factor		0.73	W/°C
Single pulse avalanche energy (Note 5)	Eas	450	mJ
Operating Junction and Storage Temperature Range	Тл ,Тѕтс	-55 To 175	°C

Thermal Characteristic

Thermal Resistance, Junction-to-Case (Note 2)	Rejc	1.36	°C/W
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Electrical Characteristics (Tc =25°Cunless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BVDSS	V _{GS} =0V I _D =250µA	80	-	-	V
Zero Gate Voltage Drain Current	loss	V _{DS} =80V,V _{GS} =0V	-	-	1	μΑ
Gate-Body Leakage Current	lgss	V _{DS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)	-					
Gate Threshold Voltage	VGS(th)	Vps=Vgs ,Ip=250µA	1.2	1.7	2.5	V
Drain-Source On-State Resistance	Rds(ON)	V _{GS} =10V, I _D =20A	-	13	16	mΩ
Forward Transconductance	g FS	V _{DS} =10V,I _D =20A	28	-	-	S
Dynamic Characteristics (Note 4)						
Input Capacitance	Clss		-	2350	-	PF
Output Capacitance	Coss	V _{DS} =25V,V _{GS} =0V F=1.0MHz	-	337	-	PF
Reverse Transfer Capacitance	Crss		-	165	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t _{d(on)}		-	12	-	nS
Turn-on Rise Time	tr	- - - - - - - - - - - - - - - - - - -	-	9	-	nS
Turn-Off Delay Time	t _{d(off)}	V _{GS} =10V,R _G =3Ω	-	20	-	nS
Turn-Off Fall Time	tr		-	18	-	nS
Total Gate Charge	Qg		-	55	-	nC
Gate-Source Charge	Qgs	V _{DS} =40V,I _D =20A V _{GS} =10V	-	13	-	nC
Gate-Drain Charge	Qgd	-	-	16	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	VsD	V _{GS} =0V,I _S =20A	_	-	1.2	V
Diode Forward Current (Note 2)	Is		-	-	50	А
Reverse Recovery Time	trr	TJ=25°C, IF=20A	-	21	-	nS
		di/dt=100A/µs (Note 3)				
Reverse Recovery Charge	Qrr	an at 1007 t pao	-	65	-	nC

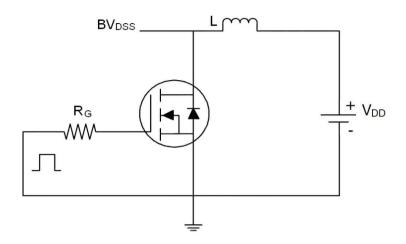
Notes:

- ① Repetitive Rating: Pulse width limited by maximum junction temperature.
- ② Surface Mounted on FR4 Board, t ≤ 10 sec.
- ③ Pulse Test: Pulse Width ≤ 300 μ s, Duty Cycle ≤ 2%.
- 4 Guaranteed by design, not subject to production
- \bigcirc EAS condition: Tj=25 $^{\circ}$ C,VDD=40V,VG=10V,L=0.5mH,Rg=25 Ω

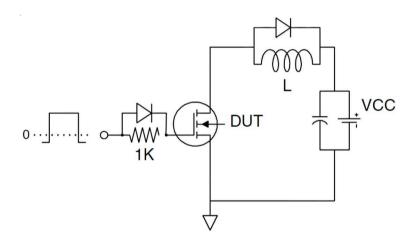




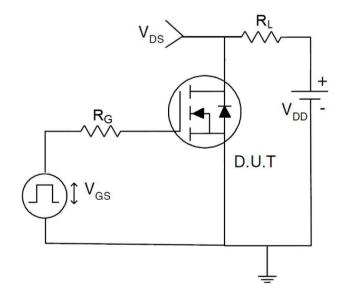
Test circuit



Eas test Circuit



Gate charge test Circuit

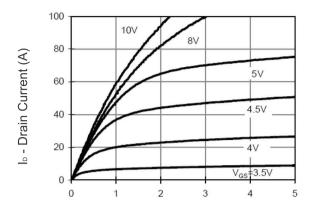


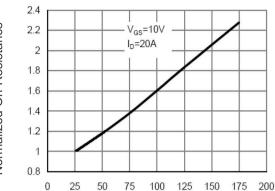
Switch Time Test Circuit



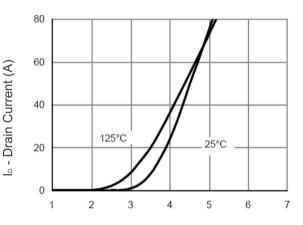


Typical Electrical and Thermal Characteristics (Curves)





Vds Drain-Source Voltage (V) Figure 1 Output Characteristics



Vgs Gate-Source Voltage (V) Figure 2 Transfer Characteristics

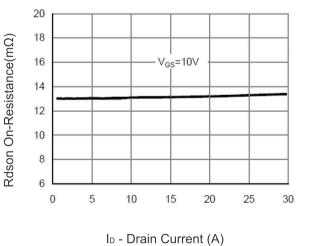
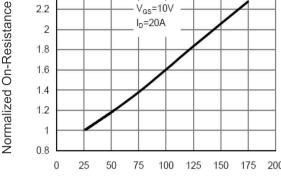
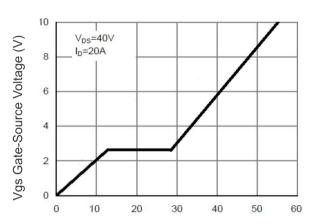


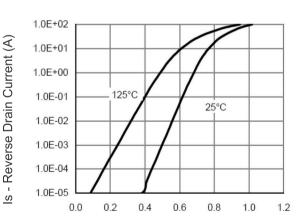
Figure 3 Rdson- Drain Current



T_J -Junction Temperature(°C) Figure 4 Rdson-Junction Temperature



Qg Gate Charge (nC) Figure 5 Gate Charge



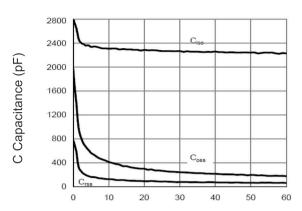
Vsd Source-Drain Voltage (V)

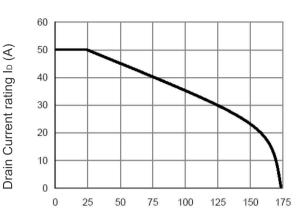
Figure 6 Source- Drain Diode Forward



lo - Drain Current (A)



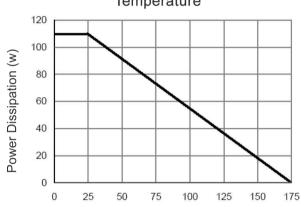




Vds Drain-Source Voltage (V)
Figure 7 Capacitance vs Vds

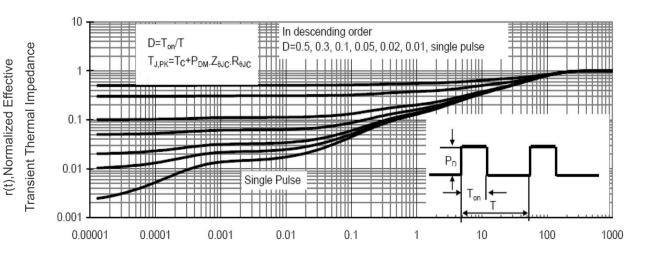
1000.0 100.0 10μs 10.0 DC 1.0 T_{J(Max)}=175°C 0.1 T_c=25°C 0.0 0.01 0.1 1 10 100 1000

Current De-rating
Figure 9 Drain Current vs Junction
Temperature



Vds Drain-Source Voltage (V)
Figure 8 Safe Operation Area

Power De-rating
Figure 10 Power vs Junction Temperature

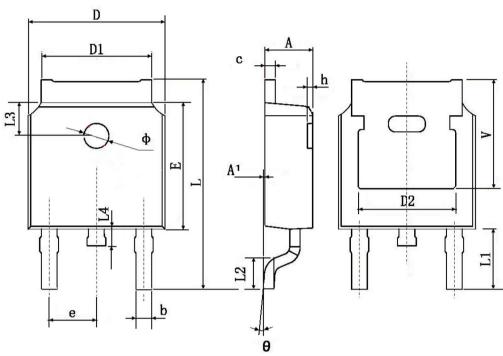


Square Wave Pluse Duration(sec)
Figure 11 Normalized Maximum Transient Thermal Impedance





TO-252 Package Information



Cross to all	Dimensions	In Millimeters	Dimension	s In Inches
Symbol	Min.	Max.	Min.	Max.
А	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
b	0.660	0.860	0.026	0.034
С	0.460	0.580	0.018	0.023
D	6.500	6.700	0.256	0.264
D1	5.100	5.460	0.201	0.215
D2	0.483	0.483 TYP. 0.190 TYP.		TYP.
E	6.000	6.200	0.236	0.244
е	2.186	2.386	0.086	0.094
L	9.800	10.400	0.386	0.409
L1	2.900 TYP.		0.114 TYP.	
L2	1.400	1.700	0.055	0.067
L3	1.600 TYP.		0.063 TYP.	
L4	0.600	1.000	0.024	0.039
Ф	1.100	1.300	0.043	0.051
θ	0°	8°	0°	8°
h	0.000	0.300	0.000	0.012
V	5.350 TYP.		0.211	TYP.





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